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## **CLAIM AMENDMENTS**

Please amend Claims 1, 14, 15, 23, 27, 52 and 53 as follows.

1. (Currently Amended) An image pick-up apparatus comprising:

a plurality of photoelectric conversion elements—and having switching elements,

arranged on a insulating substrate, wherein thicknesses of said photoelectric conversion

elements having switching elements, measured in a direction normal to the insulating

substrate, are different so as to form a step between a top of each photoelectric conversion

element and a top of a peripheral area thereof;

a wavelength converter positioned and configured to convert incident radiation to light having a wavelength detectable by said photoelectric conversion elements:

a protective layer arranged on said <u>insulating</u> substrate so as to cover said photoelectric conversion elements and said switching elements; and

an additional layer, arranged on a surface of the protective layer;

wherein a material of said additional layer is different from that of said

wherein a surface of the additional layer is flatter than the surface of the protection protective layer; and

wherein the wavelength converter comprises a columnar crystal scintillator deposited on a flat surface of said additional layer

- 2. (Previously Presented) An image pick-up apparatus according to

  Claim 1, wherein the additional layer is obtained by flattening the protective layer provided
  on the substrate.
- (Previously Presented) An image pick-up apparatus according to
   Claim 1, wherein the additional layer comprises a polyimide resin.
- 4. (Previously Presented) An image pick-up apparatus according to Claim 1, wherein a second additional layer is provided on the wavelength converter.
- (Previously Presented) An image pick-up apparatus according to
   Claim 4, wherein the second additional layer covers the end face of the wavelength
   converter.
- 6. (Original) An image pick-up apparatus according to Claim 1, wherein the surface of the wavelength converter is flattened.
- (Previously Presented) An image pick-up apparatus according to
   Claim 4, wherein a light reflection film is provided on the second additional layer.
- 8. (Previously Presented) An image pick-up apparatus according to Claim 6, wherein a light reflection film is provided on the wavelength converter.

### 9. - 10. (Cancelled)

- 11. (Previously Presented) An image pick-up apparatus according to Claim 1, wherein the scintillator comprises a CsI crystal.
- 12. (Original) An image pick-up apparatus according to Claim 7, wherein the light reflection film is made of an aluminum film.
- 13. (Original) An image pick-up apparatus according to Claim 8, wherein the light reflection film is made of an aluminum film.
- 14. (Currently Amended) An image pick-up apparatus according to Claim 8, having plural-sensor insulating substrates.
  - 15. (Currently Amended) An image pick-up apparatus comprising:
  - a plurality of insulating substrates arranged on a substrate;
- a plurality of photoelectric conversion elements and having switching elements, arranged on each of the insulating substrates, wherein thicknesses of said photoelectric conversion elements having switching elements, measured in a direction normal to the insulating substrate, different so as to form a step between a top of each photoelectric conversion element and a top of a peripheral area thereof;

a wavelength converter configured and positioned to convert incident radiation to light having a wavelength detectable by the said photoelectric conversion elements:

a protective layer arranged on the insulating substrates so as to cover the the photoelectric conversion elements and the switching elements; and

an additional layer arranged on a surface of the protective layer,
wherein a material of the additional layer is different from that of said
protective photoelectric layer,

wherein a surface of the said additional layer is flatter than the surface of said protective layer, and

wherein the wavelength converter comprises a columnar crystal scintillator deposited on a flat a surface of the said additional layer

- 16. (Previously Presented) An image pick-up apparatus according to Claim 15, wherein the additional layer is obtained by flattening the protective layer provided on the insulating substrate.
- 17. (Previously Presented) An image pick-up apparatus according to Claim 15, wherein the additional layer comprises a polyimide resin.
- 18. (Previously Presented) An image pick-up apparatus according to Claim 15, wherein the additional layer is arranged on the plurality of insulating substrates.

#### 19. - 20. (Cancelled)

- 21. (Previously Presented) An image pick-up apparatus according to Claim 15, wherein the scintillator comprises a CsI crystal.
  - 22. (Cancelled)
- an image pick-up apparatus including: a plurality of photoelectric conversion elements and having switching elements, arranged on an insulating substrate, wherein thicknesses of said photoelectric conversion elements having switching elements.

  measured in a direction normal to the insulating substrate, are different so as to form a step between a top of each photoelectric conversion element and a top of a peripheral area thereof; a wavelength converter configured and positioned to convert incident radiation to light having a wavelength detectable by the photoelectric conversion elements; a protective layer arranged on the said insulating substrate so as to cover the photoelectric conversion elements and the said switching elements; and an additional layer on a surface of the protective layer;

wherein a material of said additional layer is different from that of the said protective layer,

wherein a surface of the additional layer is flatter than the surface of the said protective layer, and

wherein the wavelength converter is comprises a columnar crystal scintillator deposited on a flat surface of the said additional layer;

a signal processor configured to process the signal from the image pick-up apparatus; and

a display configured to display the processed signal from the signal processor.

- 24. (Previously Presented) An image pick-up system according to Claim23, further comprising a telecommunication device configured to transfer the signal from the signal processor.
- 25. (Previously Presented) An image pick-up apparatus system to Claim23, further comprising a recorder configured to record the signal from the signal processor.
- 26. (Previously Presented) An image pick-up system according to Claim23, further comprising a storage device configured to store the signal from the signal processor.
- 27. (Currently Amended) An image pick-up system comprising:
  a plurality of insulating substrates arranged on a substrate; a plurality of
  photoelectric conversion elements and switching elements, arranged on each of the
  insulating substrates, wherein thicknesses of said photoelectric conversion elements having
  switching elements, measured in a direction normal to the insulating substrate, are different
  so as to form a step between a top of each photoelectric conversion element and a top of a
  peripheral area thereof; a wavelength converter configured and positioned to convert
  incident radiation to light having a wavelength detectable by the photoelectric conversion
  elements; a protective layer arranged on the insulating substrates so as to cover the plurality

of photoelectric conversion elements and switching elements; and an additional layer arranged on a surface of the protective layer;

wherein a material of said additional layer is different from that of the said protective layer,

wherein a surface of the additional layer is flatter from the surface of the said protective layer, and

wherein the wavelength converter comprises a columnar crystal scintillator deposited on a flat surface of the said additional layer;

a signal processor configured to process the signal from the image pick-up apparatus; and

a display configured to display the processed signal from the signal processing means.

- 28. (Previously Presented) An image pick-up system according to Claim 27, further comprising a recorder configured to record the processed signal from the signal processor.
- 29. (Previously Presented) An image pick-up system according to Claim27, further comprising a telecommunication device configured to transfer the signal from the signal processor.
- 30. (Previously Presented) An image pick-up system according to Claim 27, further comprising a storage device configured to store the signal from the signal processor.

# 31. - 51. (Canceled)

52. (Currently Amended) An image pick-up apparatus comprising:

a plurality of photoelectric conversion elements—and having switching
elements, arranged on—a an insulating substrate, wherein thicknesses of said photoelectric
conversion elements having switching elements, measured in a direction normal to the
insulating substrate, are different so as to form a step between a top of each photoelectric
conversion element and a top of a peripheral area thereof;

a wavelength converter configured and positioned to convert incident radiation to light having a wavelength detectable by the photoelectric conversion elements;

a protective layer arranged on the substrate so as to cover the photoelectric conversion elements and switching elements; and

an additional layer arranged on a surface of the protective layer;

wherein a material of said additional layer is different from that of the said protective layer,

wherein a surface of the additional layer is flatter than the surface of the said protective layer,

wherein the wavelength converter comprises a columnar crystal scintillator deposited on a flat surface of the said additional layer, and

wherein the photoelectric conversion elements comprise non-crystalline semiconductor material.

53. (Currently Amended) The image pick-up apparatus according to Claim 52, wherein the photoelectric conversion elements comprise an amorphous silicon

film, and the peripheral area of each photoelectric conversion element comprises an adjacent switching element.